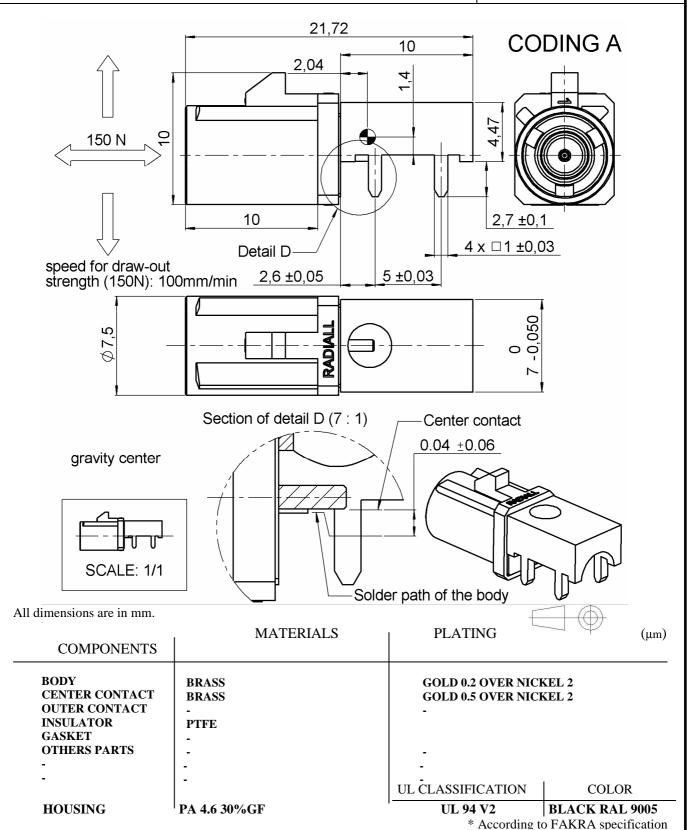
EDGE CARD - PIN IN PASTE VERSION

R197.160.A07

Series : **SMB CARLOCK**



Issue: 0611 A

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



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PACKAGING

Standard	Unit	Other	
350	'W' option	Contact us	

SPECIFICATION

QS9000

ELECTRICAL CHARACTERISTICS

Impedance 50 Ω

Frequency **0-4** GHz

VSWR **1.06*** + **0,0130** x F(GHz) Maxi

Insertion loss $0.03* \sqrt{F(GHz)} dB Maxi$ RF leakage - (-F(GHz)) dB Maxi

Voltage rating

335 Veff Maxi

 $\begin{array}{ccc} \text{Dielectric with standing voltage} & & \textbf{1000} & \text{Veff mini} \\ \text{Insulation resistance} & & \textbf{1000} & \text{M}\Omega \text{ mini} \\ \end{array}$

ENVIRONMENTAL

Operating temperature -40/+110 ° C

Hermetic seal **NA** Atm.cm3/s

Panel leakage NA

OTHER CHARACTERISTICS

Assembly instruction

Others:

μCOAX TRANSMISSION ONLY

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight 2,8200 g

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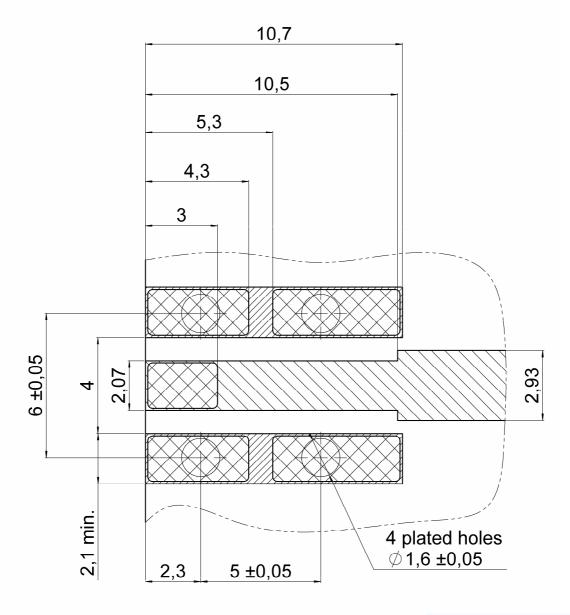


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MOUNTING ZONE FOR RECEPTACLE



Thickness of PCB: 1,6 mm.

Material of PCB: FR4 ($\varepsilon r = 4.6$).

Solder paste has to be printed onto the land of solder and into holes to permit Pin In Hole Reflow Ground track

Signal track

Land for solder

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SOLDER PROCEDURE

Deposit solder paste "Sn Ag4 Cu0.5" on mounting zone by screen printing application. We recommend a low Residue Solid Flux.

We advise a thickness of 0,2 millimetres min. (0,008 inch min.).

The holes must be totaly filled with cream

Verify that the edges of the zone are clean.

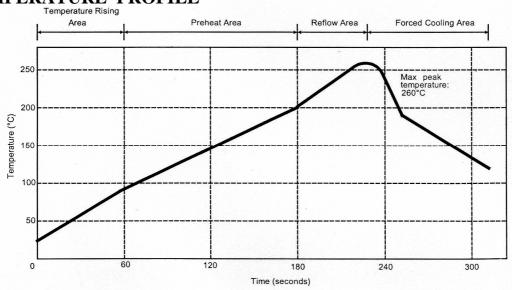
- Placement of the receptacle on the mounting zone with an automatic machine of "pick and place" type.

Video camera is preferred to check the positioning of the component.

Adhesive agents are forbidden on the receptacle.

- Soldering by reflow process.
 - The typical profile to use is given below.
- Clean printed circuit boards.
- Check of solder joints and position of the component by visual inspection

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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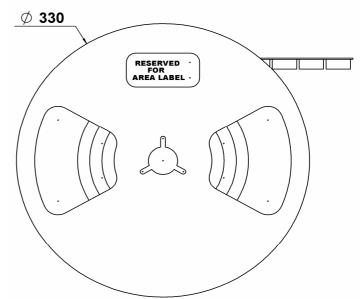
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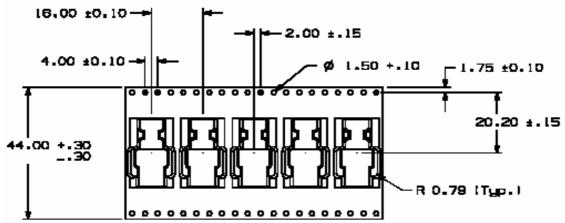
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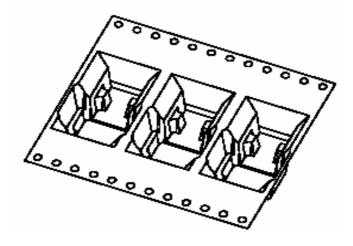
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REEL PAKAGING PER 350

CELL MATERIAL : Polycarbonate COVER TAPE MATERIAL : conductive polyester film tape







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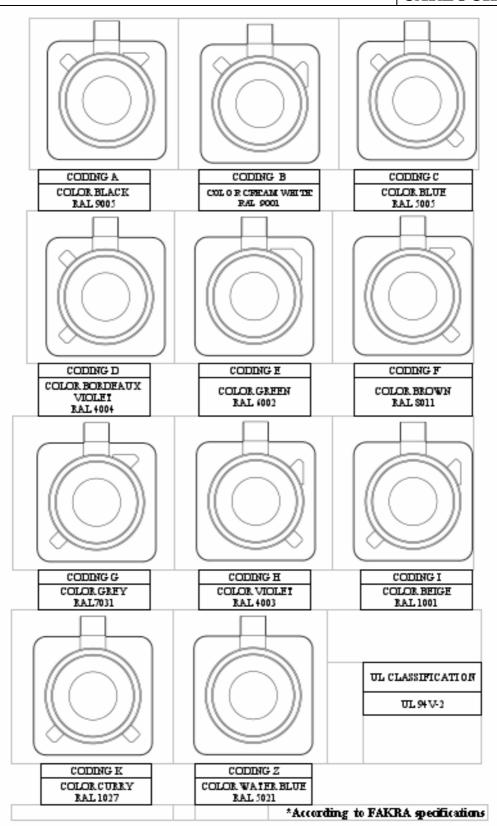
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To obtain other coding for the connector please change the letter by the needed coding letter into the Part Number

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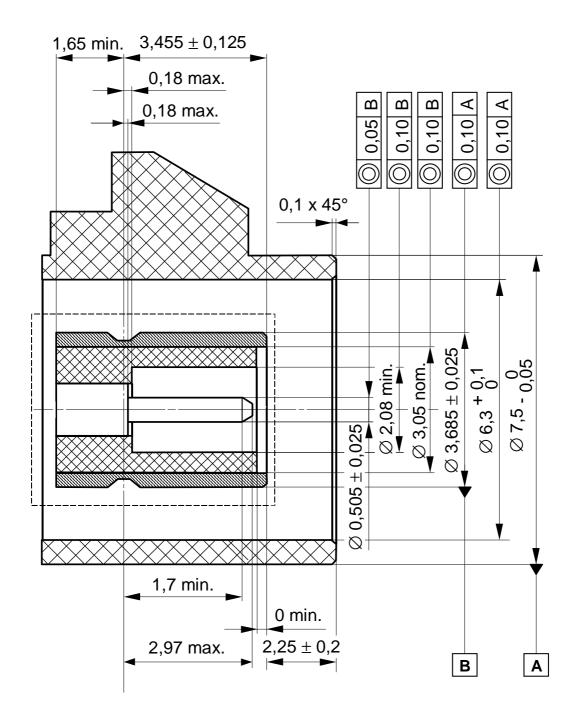
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